**CANDIDATE INFORMATION:**

|  |  |  |  |  |  |
| --- | --- | --- | --- | --- | --- |
| First Name |  | Candidate Location |  | Total Exp. (Yrs.Mth) |  |
| Last Name |  | Job Location |  | Relevant Exp. (Yrs.Mth) |  |

**Technical Round:Panel Details:**

|  |  |  |  |  |  |
| --- | --- | --- | --- | --- | --- |
| Panel Name |  | Mode of Interview | Face to Face | Interview Location |  |

**Technologies / Skills Assessed On: (Key / Mandatory technologies relevant for the position)**

|  |  |  |  |  |  |  |
| --- | --- | --- | --- | --- | --- | --- |
| **To be filled by panel** | **S.No.** | **Technology / Skills** | **Exceeds expectations\*\*** | **Meets expectations\*\*** | **Below expectations\*\*** | **Rating [1- 10]** |
|  |  |  |  |  |  |
|  |  |  |  |  |  |
|  |  |  |  |  |  |
|  |  |  |  |  |  |
|  |  |  |  |  |  |
|  |  |  |  |  |  |  |

**……………………………………………………………………………………………………………………………………………………**

**………………………………………………………………………………………………………………………………………………………**

**……………………………………………………………………………………………………………………………………………………**

**………………………………………………………………………………………………………………………………………………………**

|  |  |  |  |  |  |
| --- | --- | --- | --- | --- | --- |
| **To be filled by panel** | **S.No.** | **Areas of assessment** | **Exceeds expectations\*\*** | **Meets expectations\*\*** | **Below expectations\*\*** |
| 1 | **Communication** |  |  |  |
| 2 | **Process** |  |  |  |
| 3 | **Technical** |  |  |  |
| 4 | **Flexibility** |  |  |  |
| 5 | **Adaptability** |  |  |  |
| 6 | **Attitude (ownership, accountability, responsibility)** |  |  |  |

|  |  |  |
| --- | --- | --- |
| **Exceeds Expectations** | **Meets Expectations** | **Below Expectations** |
|  |  |  |

**Detailed interview feedback:**

|  |  |  |  |
| --- | --- | --- | --- |
| **Final Status** | Select | Reject | Signature: |